erney's Docket No. 5649-917

**PATENT** 

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

re: Chung et al.

Confirmation No.: 6119 Group Art Unit: 2813

Serial No.: 10/043,027

Examiner: William C. Vesperman

Filed: January 9, 2002 For:

METHODS OF FORMING AN INTEGRATED CIRCUIT CAPACITOR IN WHICH

A METAL PREPROCESSED LAYER IS FORMED ON AN ELECTRODE

**THEREOF** 

Date: June 18, 2004

Mail Stop Issue Fee Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

## **AMENDMENT AFTER ALLOWANCE (37 C.F.R. 1.312)**

Sir:

Applicants provide the present Amendment responsive to the Notice of Allowance" of March 26, 2004. Applicants provide the present Amendment pursuant to the rules stated in revised 37 C.F.R. 1.121 that became effective on July 30, 2003.